

October 2001 Revised May 2005

# 74ALVC16240

# Low Voltage 16-Bit Inverting Buffer/Line Driver with 3.6V Tolerant Inputs and Outputs

## **General Description**

The ALVC16240 contains sixteen inverting buffers with 3-STATE outputs to be employed as a memory and address driver, clock driver, or bus oriented transmitter/receiver. The device is nibble (4-bit) controlled. Each nibble has separate 3-STATE control inputs which can be shorted together for full 16-bit operation.

The 74ALVC16240 is designed for low voltage (1.65V to 3.6V)  $\rm V_{CC}$  applications with I/O capability up to 3.6V.

The 74ALVC16240 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining low CMOS power dissipation.

#### **Features**

- 1.65V to 3.6V V<sub>CC</sub> supply operation
- 3.6V tolerant inputs and outputs
- too

3.0 ns max for 3.0V to 3.6V  $\rm V_{CC}$  3.5 ns max for 2.3V to 2.7V  $\rm V_{CC}$  6.0 ns max for 1.65V to 1.95V  $\rm V_{CC}$ 

- Power-off high impedance inputs and outputs
- Supports live insertion and withdrawal (Note 1)
- Uses patented noise/EMI reduction circuitry
- Latchup conforms to JEDEC JED78
- ESD performance:

Human body model > 2000V Machine model > 200V

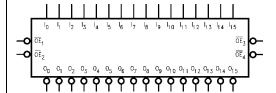
Note 1:  $\overline{\text{To}}$  ensure the high-impedance state during power up or power down, OE should be tied to  $V_{CC}$  through a pull-up resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver

# **Ordering Code:**

1			
	Order Number	Package Number	Package Descriptions
١	74ALVC16240MTD	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide
	74ALV C 16240IVI 1D	WHD48	[46-Lead Thin Shrink Small Outline Package (1550P), JEDEC MO-153, 6. Imm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

#### **Logic Symbol**



## **Pin Descriptions**

Pin Names	Description
ŌĒn	Output Enable Input (Active LOW)
I <sub>0</sub> –I <sub>15</sub>	Inputs
$\overline{O}_0 - \overline{O}_{15}$	Outputs

# **Connection Diagram**



# **Truth Tables**

Inp	Outputs	
OE <sub>1</sub>	I <sub>0</sub> –I <sub>3</sub>	$\overline{O}_0 - \overline{O}_3$
L	L	Н
L	Н	L
Н	Χ	Z

Inp	Outputs	
OE <sub>2</sub>	I <sub>4</sub> –I <sub>7</sub>	$\overline{O}_4 - \overline{O}_7$
L	L	Н
L	Н	L
Н	Χ	Z

Inp	Outputs	
OE <sub>3</sub>	I <sub>8</sub> –I <sub>11</sub>	0 <sub>8</sub> -0 <sub>11</sub>
L	L	Н
L	Н	L
Н	Χ	Z

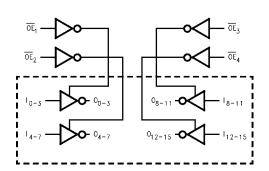
Inp	Outputs			
OE <sub>4</sub>	OE <sub>4</sub> I <sub>12</sub> -I <sub>15</sub>			
L	L	Н		
L	Н	L		
Н	X	Z		

H = HIGH Voltage Level

# **Functional Description**

The 74ALVC16240 contains sixteen inverting buffers with 3-STATE outputs. The device is nibble (4 bits) controlled with each nibble functioning identically, but independent of each other. The control pins may be shorted together to obtain full 16-bit operation. The 3-STATE outputs are controlled by an Output Enable  $(\overline{OE}_n)$  input. When  $\overline{OE}_n$  is LOW, the outputs are in the 2-state mode. When  $\overline{OE}_n$  is HIGH, the standard outputs are in the high impedance mode but this does not interfere with entering new data into the inputs.

## **Logic Diagram**



L = LOW Voltage Level
X = Immaterial (HIGH or LOW, inputs may not float)
Z = High Impedance

# Absolute Maximum Ratings(Note 2)

 $\label{eq:supply Voltage VCC} Supply Voltage (V_{CC}) & -0.5V to +4.6V \\ DC Input Voltage (V_{I}) & -0.5V to 4.6V \\ \end{array}$ 

Output Voltage (V<sub>O</sub>) (Note 3) -0.5 V to V<sub>CC</sub> +0.5V

DC Input Diode Current (I<sub>IK</sub>)

 $V_I < 0V$  –50 mA

DC Output Diode Current (I<sub>OK</sub>)

 $V_O < 0V$  –50 mA

DC Output Source/Sink Current

(I<sub>OH</sub>/I<sub>OL</sub>) ±50 mA

DC  $V_{CC}$  or GND Current per

Supply Pin ( $I_{CC}$  or GND)  $\pm 100 \text{ mA}$ 

Storage Temperature Range (T<sub>STG</sub>) -65°C to +150°C

# Recommended Operating Conditions (Note 4)

Power Supply

Operating 1.65V to 3.6V

 $\begin{array}{ll} \text{Input Voltage (V_I)} & \text{OV to V}_{\text{CC}} \\ \text{Output Voltage (V}_{\text{O}}) & \text{OV to V}_{\text{CC}} \\ \end{array}$ 

Free Air Operating Temperature (T<sub>A</sub>) -40°C to +85°C

Minimum Input Edge Rate (Δt/ΔV)

 $V_{IN} = 0.8V \text{ to } 2.0V, V_{CC} = 3.0V$  10 ns/V

Note 2: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 3: I<sub>O</sub> Absolute Maximum Rating must be observed.

Note 4: Floating or unused inputs must be held HIGH or LOW.

# **DC Electrical Characteristics**

Symbol	Parameter	Conditions	V <sub>CC</sub>	Min	Max	Units
			(V)			
V <sub>IH</sub>	HIGH Level Input Voltage		1.65 -1.95	0.65 x V <sub>CC</sub>		
			2.3 - 2.7	1.7		V
			2.7 - 3.6	2.0		
V <sub>IL</sub>	LOW Level Input Voltage		1.65 -1.95		0.35 x V <sub>CC</sub>	
			2.3 - 2.7		0.7	V
			2.7 - 3.6		0.8	
V <sub>OH</sub>	HIGH Level Output Voltage	I <sub>OH</sub> = -100 μA	1.65 - 3.6	V <sub>CC</sub> - 0.2		
		I <sub>OH</sub> = -4 mA	1.65	1.2		
		$I_{OH} = -6 \text{ mA}$	2.3	2		
		$I_{OH} = -12 \text{ mA}$	2.3	1.7		V
			2.7	2.2		
			3.0	2.4		
		$I_{OH} = -24 \text{ mA}$	3.0	2		
V <sub>OL</sub>	LOW Level Output Voltage	I <sub>OL</sub> = 100 μA	1.65 - 3.6		0.2	
		$I_{OL} = 4 \text{ mA}$	1.65		0.45	
		I <sub>OL</sub> = 6 mA	2.3		0.4	V
		I <sub>OL</sub> = 12mA	2.3		0.7	V
			2.7		0.4	
		I <sub>OL</sub> = 24 mA	3		0.55	
l <sub>l</sub>	Input Leakage Current	$0 \leq V_I \leq 3.6V$	3.6		±5.0	μΑ
I <sub>OZ</sub>	3-STATE Output Leakage	$0 \le V_O \le 3.6V$	3.6		±10	μА
I <sub>CC</sub>	Quiescent Supply Current	$V_I = V_{CC}$ or GND, $I_O = 0$	3.6		40	μА
Δl <sub>CC</sub>	Increase in I <sub>CC</sub> per Input	$V_{IH} = V_{CC} - 0.6V$	3 -3.6		750	μА

# **AC Electrical Characteristics**

		T $_{A}=-40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ , $R_{L}=500\Omega$								
Symbol	Parameter	C <sub>L</sub> = 50 pF			C <sub>L</sub> = 30 pF			Units		
Зупівої		V $_{CC}$ = 3.3V $\pm$ 0.3V		V <sub>CC</sub> = 2.7V		$V_{CC} = 2.5V \pm 0.2V$		$V_{CC} = 1.8V \pm 0.15V$		Units
		Min	Max	Min	Max	Min	Max	Min	Max	
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation Delay	1.3	3.0	1.5	3.5	1.0	3.0	1.5	6.0	ns
	Bus to Bus	1.5	3.0	1.5	5.5	1.0	3.0	1.5	0.0	115
$t_{PZL}, t_{PZH}$	Output Enable Time	1.3	4.0	1.5	4.6	1.0	4.1	1.5	8.2	ns
t <sub>PLZ</sub> , t <sub>PHZ</sub>	Output Disable Time	1.3	4.0	1.5	4.3	1.0	3.8	1.5	7.6	ns

# Capacitance

Symbol	Parameter		Conditions	<b>T</b> <sub>A</sub> =	Units	
Oyillboi			Conditions	v <sub>cc</sub>	Typical	Oilles
C <sub>IN</sub>	Input Capacitance		$V_I = 0V$ or $V_{CC}$	3.3	6	pF
C <sub>OUT</sub>	Output Capacitance		$V_I = 0V$ or $V_{CC}$	3.3	7	pF
C <sub>PD</sub>	Power Dissipation Capacitance Outputs Enabled		f = 10 MHz, C <sub>L</sub> = 50 pF	3.3	20	pF
				2.5	20	ρı

# **AC Loading and Waveforms**

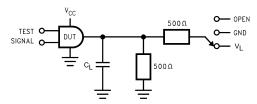


TABLE 1. Values for Figure 1

TEST	SWITCH
t <sub>PLH</sub> , t <sub>PHL</sub>	Open
$t_{PZL}, t_{PLZ}$	$V_{L}$
t <sub>PZH</sub> , t <sub>PHZ</sub>	GND

FIGURE 1. AC Test Circuit

TABLE 2. Variable Matrix (Input Characteristics: f = 1MHz;  $t_r=t_f=2$  ns;  $Z_0=50\Omega)$ 

Symbol	V <sub>CC</sub>						
Symbol	3.3V ± 0.3V	2.7V	2.5V ± 0.2V	1.8V ± 0.15V			
V <sub>mi</sub>	1.5V	1.5V	V <sub>CC</sub> /2	V <sub>CC</sub> /2			
V <sub>mo</sub>	1.5V	1.5V	V <sub>CC</sub> /2	V <sub>CC</sub> /2			
V <sub>X</sub>	V <sub>OL</sub> + 0.3V	V <sub>OL</sub> + 0.3V	V <sub>OL</sub> + 0.15V	V <sub>OL</sub> + 0.15V			
$V_{Y}$	V <sub>OH</sub> – 0.3V	V <sub>OH</sub> – 0.3V	V <sub>OH</sub> – 0.15V	V <sub>OH</sub> – 0.15V			
V <sub>L</sub>	6V	6V	V <sub>CC</sub> *2	V <sub>CC</sub> *2			

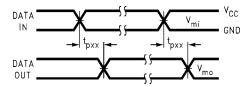


FIGURE 2. Waveform for Inverting and Non-Inverting Functions

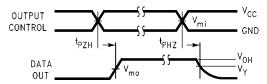


FIGURE 3. 3-STATE Output High Enable and Disable Times for Low Voltage Logic

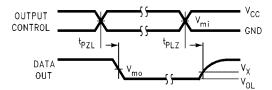


FIGURE 4. 3-STATE Output Low Enable and Disable Times for Low Voltage Logic

# Physical Dimensions inches (millimeters) unless otherwise noted 12 50±0 10 0.40 TYF -B-9.20 8 B.10 4.05 O.2 C B A ALL LEAD TIPS PIN #1 IDENT 0.50 LAND PATTERN RECOMMENDATION O.1 C ALL LEAD TIPS SEE DETAIL A 0.90+0.15 0.09-0.20 0.10±0.05 0.50 0 17-0 27 ♦ 0.13\@ A B\S C\S 12.00' TOP & BOTTOM R0.16 DIMENSIONS ARE IN MILLIMETERS CAGE PLANE 0.25 NOTES A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION ED, DATE 4/97. B. DIMENSIONS ARE IN MILLIMETERS. SEATING PLANE 0.60±0.10 C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS. D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982. DETAIL A MTD48REVC

48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Package Number MTD48

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